

Simulation-Driven Optimization of Heavy-Ion Production in ECR Sources

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Work supported by DoE SBIR Grant #DE-FG02-05ER84173

VENUS R&D focus: generation of high intensity Uranium beams

- Versatile ECR ion source for <u>NU</u>clear <u>S</u>cience
 - LBNL Superconducting ECR
 - 18/28 GHz
- World record beam of 200 eµA U^{32+} U^{34+}



Figures: VENUS Group



- Further oven developments (ongoing) are needed to improve the reliability and output of the oven
- The beam intensities are limited by the vapor • flux of uranium into the plasma
- \Rightarrow Use simulations to investigate plasma loading process

Vapor loading in ECR poses various modeling challenges

- Complex field topology
 - Requires full 3D treatment
- Large discrepancy of length/timescales
 - Debye-length ~ μ m, system size ~ m
 - Cyclotron period ~ 10^{-10} s, ionization time ~ ms
- Ionization model
 - Impact ionization for broad range of electron energies

=> VORPAL includes now all the models to perform these simulations!

VORPAL allows both electrostatic and electromagnetic simulations

- Parallel ES solver
 - Based on Sandia's AztecOO/Trilinos
 - · Variety of solvers, preconditioners
 - · Krylov subspace solver, AMG
 - Scales to large number of processors



- . E.g Speedup 111x on 128 PEs for 513 x 65 x 65 cell problem
- Arbitrary complex boundary condition
- Same simulation setup can be used to run electromagnetic simulation
 - E.g. for investigation of RF power absorption

VORPAL allows easy setup of complex magnetic field topologies



$$B_{z} = B_{0}(z) + \frac{r^{2}}{4} \partial_{z}^{2} B_{0}(z)$$
$$B_{r} = -\frac{r}{2} \partial_{z} B_{0}(z) - \frac{r^{3}}{16} \partial_{z}^{3} B_{0}(z)$$



Two methods to avoid numerical heating: Super-heavy electrons and High-order particle shapes

Noise in electron motion artificially heats plasma until grid resolves electron Debye-length

Requires fine meshes

Solution 1: Super-heavy electrons

- Contribute charge to electrostatic field
- Electrons not affected by field

Solution 2: High order particle shapes

- Requires only resolution of skin depth
- See: K. Paul et al., PAC07 THPAS023



Figure: Paul Mullowney

Kinetic ionization model in VORPAL uses cross-section models in TxPhysics library

Kinetic ionization based on DSMC algorithm

Requires cross-section model for electron impact ionization

 Variety of cross-section models available: Lotz, Shull&VanSteenberg, Kim&Rudd



Simulations show different ion populations for different neutral loading angles

- VENUS-like setup
- Neutral Oxygen injected at wall, close to bottle neck, radially or axially
 - Initial simulations using scaled cross-sections



Loading angle effects ion population



Comparison for different loading angles



Conclusions

- VORPAL is capable of simulating vapor loading in ECR
 - Parallel ES solver, ionization model, higher-order particles
- Preliminary Jimulations show effect of different loading angles
 Need more convergence studies
- Future work: Benchmarks with measurements
 - Loading at different oven locations